Overview

HP 245 G7 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Internal microphone
- 4. Touchpad
- 5. Touchpad button
- 6. Power indicator LED

Left

- 7. Hard drive indicator LED
- 8. SD Card slot
- 9. USB 2.0 port
- 10. Security lock slot (Lock sold separately)
- 11. Power button

Overview



- 1. AC Smart Pin adapter plug
- 2. RJ-45/Ethernet port
- 3. HDMI port (Cable not included)

Right

- 4. USB 3.1 Gen 1 port
- 5. USB 3.1 Gen 1 port
- 6. Audio combo jack

Overview

AT A GLANCE

- Preinstall with Windows 10 versions, FreeDOS or Ubuntu
- Choice of AMD Ryzen[™] and 7th Generation AMD APU processors
- 14" (35.56 cm) diagonal HD Anti-Glare Display
- Choice of Integrated AMD Radeon Vega or Radeon Graphics
- Dark Ash Silver color with texture pattern
- Up to 1 TB Hard Drive or 256 GB M.2 SATA3 Solid State Drive
- Weight starting at 1.52 Kg (3.4lbs)
- Security features including FW TPM 2.0 and security lock slot (Lock not included)
- Keyboard Full size textured island-style keyboard
- Touchpad with gestures support
- HP webcam with single digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera
- Two USB 3.1 (Gen 1) ports and One USB 2.0 port
- Wireless LAN (WLAN) up to 802.11ac to keep you connected

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP 245 G7 Notebook PC

OPERATING SYSTEM

Preinstalled OS Windows 10 Pro 64¹

Windows 10 Home 641

Windows 10 Home Single Language 64¹ Windows 10 Pro 64 (National Academic only)²

FreeDOS Ubuntu

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSOR

AMD Ryzen™ 5 2500U APU with Radeon™ Vega Graphics (2 GHz base frequency, up to 3.6 GHz burst frequency, 6 MB cache, 4 cores)^{3,4,5} AMD Ryzen™ 3 2200U APU with Radeon™ Vega Graphics (2.5 GHz base frequency, up to 3.4 GHz burst frequency, 5 MB cache, 2 cores)^{3,4,5} AMD A6-9225 APU with Radeon™ R4 Graphics (2.6 GHz base frequency, up to 3 GHz burst frequency, 1 MB cache, 2 cores)^{3,4,5} AMD A4-9125 APU with Radeon™ R3 Graphics (2.3 GHz base frequency, up to 2.6 GHz burst frequency, 1 MB cache, 2 cores)^{3,4,5}

Processor Family

AMD Ryzen™ 5 Mobile Processors⁵ AMD Ryzen™ 3 Mobile Processors⁵ 7th Generation AMD A6 APU processor (A6-9225) ⁵ 7th Generation AMD A4 APU processor (A4-9125)⁵

- 3. Multi core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



Technical Specifications

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon Vega 8 Mobile Graphics AMD Radeon Vega 3 Mobile Graphics AMD Radeon™ R4 Graphics AMD Radeon™ R3 Graphics

Supports

Support HD decode, DX12, HDMI 1.4b6

6. HDMI cable sold separately.

DISPLAY

Non-Touch

35.56 cm (14") diagonal HD SVA eDP anti-glare WLED-backlit slim-flat, 220 cd/m², 67% sRGB (1366 x 768)^{7,8}

HDMI

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

- 7. HD content required to view HD images.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA⁹ 500 GB 7200 rpm SATA⁹ 500 GB 5400 rpm SATA⁹

Primary M.2 Storage

128 GB SATA-3 TLC Solid State Drive⁹ 256 GB SATA-3 TLC Solid State Drive⁹

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

Technical Specifications

MEMORY

Maximum Memory

16 GB DDR4-2400 SDRAM¹⁰ 8 GB DDR4-1866 SDRAM¹⁰

Memory

16 GB DDR4-2400 SDRAM (2 X 8 GB) ¹⁰
8 GB DDR4-2400 SDRAM (1 x 8 GB)
8 GB DDR4-2400 SDRAM (2 x 4 GB) ¹⁰
4 GB DDR4-2400 SDRAM (1 x 4 GB)
8 GB DDR4-1866 SDRAM (1 x 8 GB)
4 GB DDR4-1866 SDRAM (1 x 4 GB)

Memory Slots

2 SODIMM (AMD Ryzen™ Mobile Processors)
DDR4 PC4 SODIMMS, system runs at 2400 (AMD Ryzen™ Mobile Processors)
1 SODIMM (7th Generation AMD APU processor)
Supports Dual Channel Memory
DDR4 PC4 SODIMMS, system runs at 1866 (7th Generation AMD APU processor)
All slots are customer non-accessible / non-upgradeable

NOTE: All slots are customer non-accessible / non-upgradeable.

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek 802.11ac (2x2) WLAN and Bluetooth® 4.2 Combo (MU-MIMO supported)¹¹
Realtek 802.11ac (1x1) WLAN and Bluetooth® 4.2 Combo¹¹
Realtek 802.11b/g/n (1x1) WLAN and Bluetooth® 4.2 Combo¹¹

Miracast

Compatible with Miracast-certified devices¹²

Ethernet

Integrated 10/100/1000 GbE NIC

- 11. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.
- 12. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers



Technical Specifications

Camera

HP TrueVision HD Camera 7,13

Webcam

VGA webcam^{13,14}

- 7. HD content required to view HD images.
- 13. Sold separately or as an optional feature.
- 14. Internet access required.

KEYBOARDS/TOUCHPAD

Keyboard

Full Size Island-style Keyboard

Pointing Device

Touchpad with multi-touch gesture support

Function Keys

- F1 Open " How to get help in Windows 10" webpage
- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switching
- F5 Blank
- F6 Mute
- F7 Volume Down
- F8 -Volume Up
- F9 Previous
- F10 Play/Pause
- F11 Next
- F12 Airplane mode



Technical Specifications

SOFTWARE AND SECURITY

Preinstalled Software

HP JumpStart
HP Documentation
HP Setup Integrated 00BE
HP SSRM
HP Audio Switch
HP SUPPORT ASSISTANT
McAfee LiveSafe™
HP Support Assistant¹⁵

Security Management

TPM 2.0¹⁶

Security lock slot (Lock sold separately)

15. HP Support Assistant requires Windows and Internet access.

16. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).re TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

POWER

Power Supply

65 W EM Smart AC adapter^{17,19} 45 W Smart AC adapter¹⁷

Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion Battery¹⁸
Support battery fast charge - Approximately 90% in 90 minutes¹⁹

Battery Life

Up to 10 hours and 45 minutes²⁰

Power Cord

1M (3.28 feet) length power cord¹⁷

- 17. Availability may vary by country.
- 18. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 19. Recharges the battery up to 90% within 90 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 90% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 20. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



Technical Specifications

WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.3 lb²¹ Starting at 1.52 kg²¹

Product Dimensions (w x d x h)

13.19 x 9.21 x 0.78 in 33.5 x 23.4 x 1.99 cm

21. Weight will vary by configuration.

PORTS/SLOTS

Ports/Connectors

2 USB 3.1 Gen 1 1 USB 2.0

1 HDMI v1.4b6

1 RJ-45

1 AC power

1 Headphone/microphone combo jack

Expansion Slots

1 multi-format digital media reader Supports SD, SDHC, SDXC

6. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. Onsite service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. ²²

22. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19.5 V Average Operating Power Win 10 Integrated graphics 8.98W

Max Operating Power Discrete < 65W

UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms duration, half-sine Non-operating 240 G, 2 ms duration, half-sine

Random Vibration

Operating 1.043 grms
Non-operating 3.5 grms

Planned Industry Standard Certifications

UL Yes
CSA No
FCC Compliance Yes
ENERGY STAR® Yes²³

EPEAT Silver²⁴

ICES Yes Australia Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes



Technical Specifications

CIT Yes **GOST** Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

23. Configurations of the HP ProBook 430 G6 that are ENERGY STAR® certified2 are identified as HP ProBook 430 G6 ENERGY STAR on HP websites and on http://www.energystar.gov.

24. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14" HD WLED Anti-Glare Outline Dimensions diagonal (1366x768) slim-flat (3.0mm), SVA, Active Area eDP

 $(W \times H \times D)$

320.9 x 250.6 x 3.0

309.5 x 174.05 Weight 270g max **Diagonal Size** 14.0 (inch) Thickness 3.0 (mm) max

Interface eDP 1.2 **Surface Treatment** AG **Touch Enabled** No

Contrast Ratio 600:1 (typ. AG)

Refresh Rate 60Hz

Brightness 220nits typical **Pixel Resolution** 1366 x 768 (HD)

> **RGB Format**

Backlight LED Color Depth 6 bits

Viewing Angle 45/45/20/40



Technical Specifications

STORAGE AND DRIVES

500 GB 5400 rpm SATA Dard Drive Weight92g(0.20lb)DriveRotation speed5400 rpm

Cache Buffer Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 16 ms Maximum: 18 ~ 22 ms

Logical Blocks 976,773,168

Operating Temperature 0° to 60°C

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA Hard Drive Weight92g(0.20lb)DriveRotation speed7200 rpm

Cache Buffer Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 13 ms

Maximum: 18 ~ 22 ms

Logical Blocks976,773,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

Technical Specifications

1 TB 5400 rpm SATA Hard Drive Drive Weight90g(0.198lb)Rotation speed5400 rpmCache BufferUp to 128MBHeight<7.2mm</th>

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0
Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 16 ms Maximum: 18 ~ 22 ms

Logical Blocks976,773,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

128 GB 2280 M2 SATA-3 TLC Drive Weight Solid State Drive

Solid State Drive

Drive Weight 0.02 lb (10 g)

NAND Type/Size TLC/128GB

Height 0.09 in (2.3 mm)

Width 0.87 in (22 mm)

Interface ATA-8, SATA 3.0

Transfer Rate 550MB/s
Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

0.02 lb (10 q)

Security Features ATA Security

Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 SATA-3 TLC Drive Weight

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

 Transfer Rate
 550MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP



Technical Specifications

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822BE 802.11 ac 2x2 WLAN and Bluetooth® 4.2 Combo Adapter (MU-MIMO supported) Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac

Interoperability Wi-Fi® certified **Frequency Band** 802.11b/g/n

•2.402 - 2.482 GHz

802.11a/n

•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

 IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

Output Power²

IEEE 802.11 compliant roaming between access points

• 802.11b: +14dBm minimum • 802.11g: +12dBm minimum

• 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum

Technical Specifications

• 802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption Transmit mode: 2.0 W

Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to

support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF; LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth® Specification4.0/4.1/4.2 CompliantFrequency Band2402 to 2480 MHzNumber of AvailableLegacy: 0~79 (1 MHz/CH)



Technical Specifications

Channels BLE: 0~39 (2 MHz/CH)

Legacy: 3 Mbps Signaling data rate1

Signaling Data Rate BLE: 1 Mbps Signaling data rate1

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Realtek RTL8821CE 802.11 ac 1x1 WLAN and Bluetooth® 4.2 Combo Adapter (MU-MIMO supported)

Wireless LAN Standards IEEE 802.11a

> IEEE 802.11b IEEE 802.11q IEEE 802.11n IEEE 802.11ac

Wi-Fi® certified Interoperability **Frequency Band** 802.11b/q/n

•2.402 - 2.482 GHz

802.11a/n

•4.9 – 4.95 GHz (Japan) •5.15 - 5.25 GHz •5.25 - 5.35 GHz •5.47 - 5.725 GHz •5.825 - 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

> •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

Security³

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i



Technical Specifications

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

• 802.11b: +14dBm minimum

• 802.11g: +12dBm minimum • 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption

•Transmit mode 2.0 W

•Receive mode 1.6 W

•Idle mode (PSP) 180 mW (WLAN Associated) •Idle mode 50 mW (WLAN unassociated)

•Connected Standby 10mW •Radio disabled 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³

802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type

High efficiency antenna.

One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

Technical Specifications

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
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HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth® Specification 4.0/4.1/4.2 Compliant
Frequency Band 2402 to 2480 MHz
Number of Available Legacy: 0~79 (1 MHz/CH)

Channels Legacy: 0~79 (1 MHz/Cl **Channels** BLE: 0~39 (2 MHz/CH)

> Legacy: 3 Mbps Signaling data rate¹ BLE: 1 Mbps Signaling data rate¹

Signaling Data Rate

BLE: 1 Mbps Signaling data rate¹

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)"

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Realtek RTL8723DE 802.11 bgn 1x1 WLAN and Bluetooth® 4.2 Combo Adapter

Wireless LAN Standards IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n

IEEE 802.11ac
Wi-Fi® certified

Interoperability Wi-Fi® certifie **Frequency Band** 802.11b/g/n

•2.402 - 2.482 GHz

802.11a/n

•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 7, (20MHz, and 40MHz)

Technical Specifications

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +14dBm minimum

• 802.11g: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum

Power Consumption Transmit mode: 2.0 W

Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11g, 6Mbps: -86dBm maximum 802.11g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum

Antenna type High efficiency antenna.

One embedded dual band 2.4/5 GHz antenna is provided to the card to

support WLAN communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Technical Specifications

LED Activity

Channels

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF: LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth® Specification4.0/4.1/4.2 CompliantFrequency Band2402 to 2480 MHzNumber of AvailableLegacy: 0~79 (1 MHz/CH)

Legacy: 3 Mbps Signaling data rate up to 2.17 Mbps¹

Signaling Data Rate BLE: 1 Mbps Signaling data rate up to 0.2 Mbps¹

BLE: 0~39 (2 MHz/CH)

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)"

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Realtek Ethernet (10/100/1000)

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE (Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

Power Management ACPI compliant - multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Technical Specifications

Large send offload and Giant send offload

Receiving Side Scaling

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30)

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 to support ASPM L1

NIC Device Driver Name Realtek PCIe GBE Ethernet Family Controller

POWER

HP 45 W AC adapter Dimensions (H x W x D) 95 x 40 x 26.5mm

Weight 200 g

Input 100 to 240 VAC

Input Efficiency 87.8 % at 115 VAC and 88.5 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.4 A at 90 VAC

Output Output power 45W

DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 8 Amperes.

Connector 4.5mm Barrel Type

Environmental Design Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, noncondensing, both operating and non-operating.

*CE Mark - full compliance with LVD and EMC directives

Certifications * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

B.

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W Smart AC adapter Dimensions ($H \times W \times D$)

Weight 270 a

EMI and Safety

(EM)

102 x 55 x 30mm

Technical Specifications

Input 100 to 240 VAC

Input Efficiency 88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.7 A at 90 VAC

Output Output power 65W

DC output 19.5V

Hold-up time 5ms at 115 VAC input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 11 Amperes.

Connector 4.5mm Barrel Type

Environmental Design Operating 32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, noncondensing, both operating and non-operating.

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

В,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Li-Ion Long Life Dimensions -Fast Charge (41 WHr) Weight

Dimensions 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

Weight 0.18 kg (0.39 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 515974

Voltage 11.4V Amp-hour capacity 3.6Ah Watt-hour capacity 41Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

.....

No

HP 3-cell Li-Ion Long Life Dimensions
-Fast Charge (41 WHr) Weight

Dimensions 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

Weight 0.19 kg (0.41 lb)

Cells/Type 3cell Lithium-Ion Prismatic cell / 496080

Voltage 11.55V

Amp-hour capacity 3.615Ah/3.63Ah

Watt-hour capacity 41Wh

Operating (Charging) 32° to 113° F (0° to 45° C)

Technical Specifications

Operating (Discharging) 14° to 122° F (-10° to 60° C)
Optional Travel Battery
Available
No



Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Messenger Case (up to 17.3")	H1D25AA
Docking	HP 3005PR USB3 Port Replicator	Y4H06AA
	HP USB Travel Dock	TOK30AA
	HP Monitor Stand	M9X76AA
Input / Output	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP HDMI to DVI Adapter	F5A28AA
	HP Stereo USB Headset	T1A67AA
	HP Stereo 3.5mm Headset	T1A66AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA#XXX
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP 65W Slim AC Adapter	H6Y82AA#xxx
Memory	HP 4GB 2666Mhz DDR4	4VN05AA
	HP 8GB 2666Mhz DDR4	4VN06AA
Storage	HP External USB Optical Drive	F2B56AA
	HP External USB Optical Drive	F2B56AA
Displays	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP EliteDisplay E223 21.5-inch Monitor	1FH45AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA



Summary of Changes

Date of change:	Version History:		Description of change:
March 1, 2019	From v1 to v2	Removed	USB-C Travel Dock
March 4, 2019	From v2 to v3	Removed	Battery Life
March 25, 2019	From v3 to v4	Added	Battery Life

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